Report of STAR discussion meeting on the inner and forward tracking upgrade

Part I: Overview of physics case, possible tracking layout and technology choices



Part II: Discussion on upgrade strategy, staging of various projects and overall organization



Outline of meeting - Part I

N. Smirnov: Possible layout of

D. Majka: Overview of the STAR future upgrade plans

D. Lynn: Report on status and future of STAR SVT/SSD

J. Kiryluk: W event kinematics

S. Vigdor: Overview of pp physics topics

K. Schweda: Overview of Au-Au physics topics



M. Miller: STAR tracking software

G. v. Nieuwenhuizen: MIT Silicon laboratory

R. Milner: MIT-BATES infrastructure

H. Wieman: Report on Pixel activities

N. Smirnov: Report on GEM activities





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Requirements

Keep (expand) STAR's large coverage

1. Enhanced (higher momentum) PID – barrel TOF

2. Micro vertex detector and inner tracking for enhanced heavy quark ID

3. Improved momentum resolution for forward (1< $|\eta|$ <2) region - intermediate and end cap tracking,

4. High rate readout and DAQ – present large samples to high level trigger, also record very large samples

5. High rate tracking capability

6.High Luminosity, Large pp polarization – RHIC development and upgrades



STAR Upgrades Required for Physics Program •Full Barrel MRPC TOF Tracking upgrade: High precision APS pixel vertex detector Inner tracker •End cap tracker DAQ Upgrade (order of magnitude increase in rate) •Compact, Fast TPC for high luminosity tracking.



Intermediate Tracking + Forward Tracking

GEM pad or strip chambers:

Endcap – GEM pad or strip chambers to help resolve sign of e[±] from W[±] decay – polarization of sea anti- u,d.

Intermediate tracker (GEM plus Si to help match TPC tracks to pixel detector and, give intermediate point for forward tracking Patch of GEM pads at outer radius to help TPC calib.



Proposed Timeline for STAR Upgrades											
Fiscal Year	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013
MRPC TOF											
Pixel micro-vertex											
Inner Tracker											
EndCap Tracker											
DAQ1000											
FEE Upgrade											
GEM TPC											
Key:	R&D	Construction/Partial Deployment			Full System						
MRPC TOF – US proposal submitted, Detector R&D Spectacular success Pixel µVertex – Draft proposal by end of year											
The proposal by end of year											
Inner Tracker / EndCap Tracker (+µVtx) Design Coordination Meeting, MIT, Nov. 7-8, 2003											
DAQ1000+FEE – DAQ R&D to start next spring											
GEM Compact Fast TPC - Full R&D in FY04, Prototype module in one year											



D. Lynn: Report on status and future of STAR SVT/SSD

Status and Future Prospects of the SVT (and SSD)

SVT

Speed/Upgradeability (with regards to DAQ1000)

Percentage of detector that is working and will be working

Reparability

Resolution/Performance

SSD

Speed/Upgradeability (with regards to DAQ1000)

Resolution



D. Lynn: Report on status and future of STAR SVT/SSD

Possibility of Repairs to SVT

- ~13% bad channels are currently known to be bad.
- · About 7% are (what I call) grouped failures, i.e. 1/4 ladder or more.
- · 6% are what I call random (i.e. less than 1/4 ladder)

What is the main difference?

Grouped failures are potentially reparable. Random failures are not (or highly unlikely) reparable. I consider a grouped failure as potentially reparable because it implies a common source which implies it is off-hybrid and thus possible to re-work.

Unfortunately ...

What is required to repair any bad channels?

- 1. Complete disassembly of SVT into individual ladders.
- Replacement (by sawing off) of water fittings. New design would be needed for new water fittings.
- 3. Debug and repairs of grouped failures
- 4. Estimate would take on the order of a year---would have to miss a running period.
- My guestimate from experience is that one could anticipate an additional 10% new damage...SVT wasn't really designed to come apart easily.

Conclusion: Will probably not want to attempt to repair SVT unless failures are too large for physics and the dominated by "grouped" failures.

Summary

- · SVT working reasonably well
- Hope that the percentage of working channels remains high enough until DAQ1000 ends the SVT's useful life.
- · If not, decision to repair depends on nature of failures and anticipated benefits.
- SSD has potential future after DAQ1000 depending on performance and new physics goals.





Spin Physics Requiring Upgraded STAR Tracking

S. Vigdor, MIT, Nov. 7, 2003

Two basic measurement programs from STAR Decadal Plan:

- 1) W^{\pm} Production in $\vec{p} + \vec{p}$ Collisions
- Physics Goal: What is the mechanism for producing the qq sea?
- Measure: $\Delta \overline{u}(x)$ vs. $\Delta \overline{d}(x)$ via parity-violating helicity asymmetries
- > Endcap region important for clean Δq vs. $\Delta \overline{q}$ distinction
- Improved forward tracking essential to distinguish e⁺ vs e⁻, hence flavor-dependence, important for improved e/h discrimination
- 2) Transverse Single Spin Asymmetries for Heavy Quark Jets
- Physics Goal: Can effect of explicit χSB m_g-dependent terms in L_{QCD} be seen in transverse spin asymmetries at high p_T?
- Measure: transverse analyzing power (sensitivity to incident p spin) for open c,b hadron prod'n; transverse pol'n of outgoing Λ_c^+ or Λ_b (averaging over p spins), via self-analyzing decays
- Microvertex + improved inner tracking needed to identify c,b displaced vertices









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J. Kiryluk: W event kinematics





Experimental Issues for W Detection in STAR

> Triggering: easy – very large p_T in single EMC tower (B or E)

> e/h Discrimination: ~ 1 order of magnitude apiece from:

* Isolation of detected particle from other jet fragments

Absence of accompanying jet at opposite azimuth (dijet rejection cut serves as "poor man's" missing energy cut)

***** EMC response: $E_{preshower}$, E_{SMD} , $E_{postshower}$ (for EEMC) vs. E_{shower} ; E_T (EMC) vs. p_T (TPC + fwd. Tracking)

should \Rightarrow W signal/hadron bkgd > 1 for p_T^e > 20 GeV/c (most of W decay phase space), but improved p_T determination very useful!

e⁺ vs. e⁻ Charge Sign Discrimination: OK for BEMC, but needs improved forward tracking for EEMC! (see N. Smirnov simulations)



K. Schweda: AuAu physics topics



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K. Schweda: AuAu physics topics



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Bernd Surrow







- One particle / event
- Pt uniform in (10 40) GeV/c
- Vz : σ_z = 12. cm. Vertex position is not in a fit

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• Hits – gaussian smearing (cm)

"SVT": \sigma_{drift}=0.005, \sigma_{pad}=0.05

"GEM in front TPC": \sigma_{r\phi}=0.01, \sigma_z=0.87 (3./\sqrt{12})

"GEM behind TPC": \sigma_{r\phi}=0.01, \sigma_z=2.02 (7./\sqrt{12})

"TPC": \sigma_{r\phi}=0.04, \sigma_z=0.06

" Si ": \sigma_{r\phi}=0.005, \sigma_z=0.87 (3./\sqrt{12})

"GEM in front EEMC": \sigma_{r\phi}=0.01, \sigma_r=1.44 (5./\sqrt{12})
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Helix fit for different variants of selected hits







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H. Wieman: Report on Pixel activities

Features

- 2 layers
- Inner radius ~1.8 cm
- Active length 20 cm
- Readout speed 20 ms (generation 1)
- Number of pixels 130 M

Mechanical

- Rapid insertion and removal for replacement and changing detector configuration
- Minimum thickness: 50 Micron Si Detector 50 Micron Si Readout chip
- Air cooling
- Composite beam pipe?

Conclusion

- Micro-vertex detector is being designed to go inside SVT
- It is being designed for rapid insertion and removal
- Should be flexible with a variety of detector designs









An intensive R&D of many groups demonstrated:

Detectors on a basis of GEM technology can be

- reliable (COMPASS, two years experience)
- high gas amplification (multiple GEMs: up to 10⁶)
- fast (< 20 ns FWHM, rate capability up to 10⁵ Hz/mm²)
- low mass (50 µm Kapton+10 µm Cu; small thickness read-out plane; small size, low Z frame material)
- 1d-, 2d- good space resolution (~50 µm)
- not complicated and in-expensive in a construction

tracking devices that are working with different gases, inside of a strong magnetic field and for a very broad application variants.

Detector response simulation is in a "reasonable" shape.





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Triple GEM detector for COMPASS

- Active area: 30.7 x 30.7 cm²
- 2-dimensional readout with
- 2 x 768 strips @ 400 μm pitch
- 12+1 sectors GEM foils (to reduce discharge energy)
- Central Beam Killer 5 cm Ø (remotely controlled)
- Total thickness: 15 mm
- Low mass honeycomb support plates





B. Ketzer et al, IEEE Trans. Nucl. Sci. NS-48(2001)1065 C. Altumbas et al, Nucl. Instrum. Methods A490(2002)177





STAR tracking upgrade meeting Cambridge, 11/07/2003



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M. Miller: STAR tracking software

Forward Tracking: Software

- 1. New components: reconstruction and simulation
- 2. Current software components
- 3. Current status of ITTF tools







M. Miller: STAR tracking software







Silicon Lab Infrastructure

Hughes 2470-V bonder



Inspection stations



Gluing Station





Probe Station



Clean Room

Survey Station Source Test Stations

Wow, great, so what did you do with it?.....



Two Rto Spectrometer Arms



Light in the Tunnel, this is what it took.....

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Conclusion

- MIT/LNS Si-Tracker modules
 - We have the facilities
 - We have experienced people
 - We have proven to deliver (PHOBOS)
- Time needed to build a 3(6) layer tracker modules
 - Assuming continuous delivery of parts
 - Assuming high sensor yield
 - 1 year



R. Milner: MIT-BATES infrastructure



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Bates Linear Accelerator Center

• Staff

DOE support 65 FTE MIT support 20 FTE

Infrastructure

Machine, vacuum, welding and electrical shops, High bay space, Offices for ~100 people, Conference rooms etc.

Accelerator complex
 Polarized + thermionic injectors
 500 MeV pulsed linac + recirculator
 South Hall Ring

Future Plans

- DOE and MIT have agreed that NP user facility will be phased out after BLAST
- BLAST production taking anticipated to start in next several weeks
- Present understanding between DOE/NP and MIT/LNS is that full staff will be supported through FY05
- DOE/NP has been supportive of NP research at Bates after user facility is phased out
- DOE/NP has invited a proposal from MIT/LNS as to activities at Bates in FY06 and beyond by end of this calendar year









Summary of discussion session - Part II

- Where do we go from here?
 - Discussion on inner/forward tracker upgrade strategy
 - Optimal sequence and staging of tracking proposals and upgrade plans

What needs to be done?

- > Formulation of task list:
 - 1. Simulation (GEANT, physics simulation)
 - 2. Overall detector layout
 - 3. Detailed specific detector design
- Who is interested to look into what (Institutional responsibilities)?
 - Simulation work
 - R&D activities
 - > Detector design and prototype

Formation of a working group within STAR and coordination?

Discussion on funding?



When do we meet again?





Summary:

- RHIC SPIN long-term goal (Requires continuous development of pp luminosity!):
 ⇒ Explore spin structure of QCD sea and flavor dependence through W production
 ⇒ Required for this are precise and fast tracking detectors as a result based on first GEANT simulation work:
 - EEMC forward tracker (1 < η < 2)
 - Inner/forward tracking (Extension of η coverage beyond η = 1 (Current SVT!) is necessary!)
 - Potential technology: Combination of Silicon / GEM detectors
- SVT performance (SVT is not a fast detector) and maintenance is a concern! Repair is problematic!
- Heavy quark physics is of great interest!
- Forward physics has attracted a lot of interest! Forward tracking in the acceptance region beyond η = 2 will be important, e.g. through forward silicon wheels and GEM's
- Pixel mechanical design ideas of being replaceable is difficult with the current FTPC! Starting with a new inner tracker design with forward acceptance (Pixel + inner detector system with forward acceptance) could be advantageous!



Outlook:

- MIT LNS silicon laboratory and MIT-BATES exist together with experienced personnel to strongly participate in the STAR tracking upgrade
- GEM micro-pattern facility needed (Yale and MIT-BATES)
- Estimated time-scale to build a new silicon tracker will take 1-2 years once the sensor material is in hand based on direct experience from PHOBOS
- Need of a forum (New working group!) where to discuss and organize those tracking upgrade projects
- Possible outlook towards a new inner/forward tracker for STAR:
 - 1. Conceptual design of a new inner/forward tracker which fulfills the pp and AuAu needs by beginning of FY05
 - 2. Prototype and evaluation of possible silicon sensors (MIT LNS silicon laboratory)
 - 3. First engineering layout (Draft proposal) by January 2005
 - 4. Proposal by summer 2005 (After FY05 RHIC pp run)
 - 5. First installation of pixel and minimal inner/forward tracking system (W physics case) starting 2007/2008
 - 6. Completion of installation by 2008/2009

